

1MHz, High-Efficiency, Step-Up Converter for 2 to 6 White LEDs

start-up.

packages.

General Description

white LEDs in series.

The APW7208 is a current-mode and fixed frequency

boost converter with an integrated N-FET to drive up to 6

The series connection allows the LED current to be iden-

tical for uniform brightness. Its low on-resistance of N-

FET and feedback voltage reduces power loss and

achieves high efficiency. Fast 1MHz current-mode PWM

operation is available for input and output capacitors and

a small inductor while minimizing ripple on the input

supply. The OVP pin monitors the output voltage and stops switching if exceeds the over-voltage threshold. An inter-

nal soft-start circuit eliminates the inrush current during

The APW7208 also integrates under-voltage lockout,

over-temperature protection and current limit circuits. The APW7208 is available in SOT-23-6 and TSOT-23-6

Features

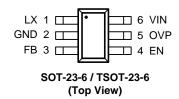
- Wide Input Voltage from 2.5V to 6V
- 104mV Reference Voltage
- Fixed 1MHz Switching Frequency
- High Efficiency up to 88%
- 100Hz to 100kHz PWM Brightness Control Frequency
- **Open-LED Protection**
- **Under-Voltage Lockout Protection**
- **Over-Temperature Protection**
- <1mA Quiescent Current During Shutdown
- SOT-23-6 and TSOT-23-6 Packages
- Lead Free and Green Devices Available (RoHS Compliant)

Applications

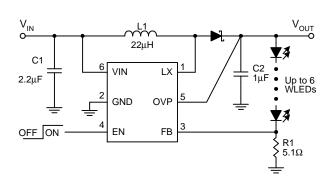
- White LED Display Backlighting
- **Cell Phone and Smart Phone**
- PDA, PMP, and MP3
- **Digital Camera**

Rev. A.6 - Aug., 2011

Pin Configuration



Simplified Application Circuit

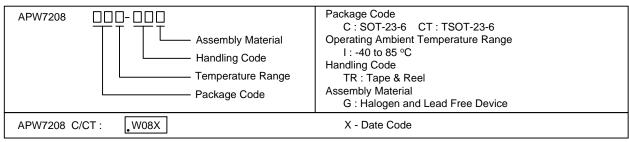


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Ordering and Marking Information



Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Absolute Maximum Ratings (Note 1)

Symbol	Parameter	Rating	Unit
V _{IN}	VIN Supply Voltage (VIN to GND)	-0.3 ~ 7	V
	FB, EN to GND Voltage	-0.3 ~ V _{IN}	V
V _{LX}	LX to GND Voltage	-0.3 ~ 34	V
V _{OVP}	OVP to GND Voltage	-0.3 ~ 32	V
TJ	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature	-65 ~ 150	°C
T _{SDR}	Maximum Lead Soldering Temperature, 10 Seconds	260	°C

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Thermal Characteristics

Symbol	Parameter	Typical Value	Unit
	Junction to Ambient Thermal Resistance (Note 2)	050	0000
θ_{JA}	SOT-23-6 T-SOT-23-6		°C/W

Note 2: θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. The exposed pad of package is soldered directly on the PCB.

Recommended Operating Conditions (Note 3)

Symbol	Parameter	Range	Unit		
V _{IN}	VIN Input Voltage	2.5 ~ 6	V		
V _{OUT}	Converter Output Voltage Up to 24				
C _{IN}	Input Capacitor	2.2 or higher	μF		
C _{OUT}	Output capacitor	0.47 or higher	μF		
L1	Inductor	6.8 ~ 22	μН		
T _A	Ambient Temperature	-40 ~ 85	°C		
TJ	Junction Temperature	-40 ~ 125	°C		

Note 3: Refer to the application circuit for further information.



Electrical Characteristics

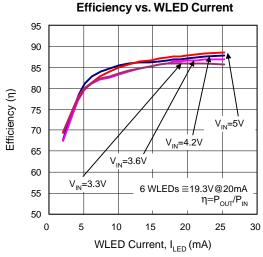
(Refer to figure 1 in the "Typical Application Circuits". These specifications apply over $V_{IN} = 3.6V$, unless otherwise noted. $T_A = 25^{\circ}C$.)

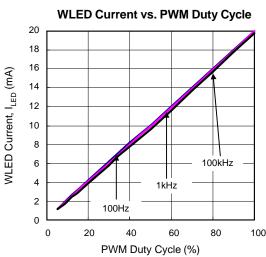
Symbol	Domonoston	Took Conditions		APW7208			
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
SUPPLY	VOLTAGE AND CURRENT	·	•	•			
V _{IN}	Input Voltage Range	T _A = -40 ~ 85°C, T _J = -40 ~ 125°C	2.5	-	6	V	
I _{DD1}		V _{FB} = 0.3V, no switching	70	100	130	μΑ	
I _{DD2}	Input DC Bias Current	FB = GND, switching	-	1	2	mA	
I _{SD}		EN = GND	-	-	1	μΑ	
UNDER-V	OLTAGE LOCKOUT						
	UVLO Threshold Voltage	V _{IN} Rising	2.2	2.3	2.48	V	
	UVLO Hysteresis Voltage		50	100	150	mV	
REFEREN	NCE AND OUTPUT VOLTAGES						
V_{REF}	Regulated Feedback Voltage	T _A = 25°C	101	104	107	mV	
I _{FB}	FB Input Current		-50	-	50	nA	
INTERNA	L POWER SWITCH	•					
Fsw	Switching Frequency	FB=GND	0.8	1.0	1.2	MHz	
Ron	Power Switch On Resistance		-	0.6	1.2	Ω	
I _{LIM}	Power Switch Current Limit		-	1.2	-	Α	
	LX Leakage Current	$V_{EN}=0V$, $V_{LX}=0V$ or 5V, $V_{IN}=5V$	-1	-	1	μΑ	
D _{MAX}	LX Maximum Duty Cycle		92	95	98	%	
OUTPUT	OVER-VOLTAGE PROTECTION	•					
V _{OVP}	Over Voltage Threshold		26	28	30	V	
	OVP Hysteresis		1	-	4	V	
	OVP Leakage Current	V _{OVP} =24V	-	-	45	μΑ	
ENABLE	AND SHUTDOWN	•					
V_{TEN}	EN Voltage Threshold	V _{EN} Rising	0.4	0.7	1	V	
	EN Voltage Hysteresis		0.05	0.1	0.15	V	
I _{LEN}	EN Leakage Current	V _{EN} = 0~5V, V _{IN} = 5V	-1	-	1	μΑ	
OVER-TE	MPERATURE PROTECTION		•				
T _{OTP}	Over-Temperature Protection	T_J Rising	-	150	-	°C	
	Over-Temperature Protection Hysteresis		-	40	-	°C	

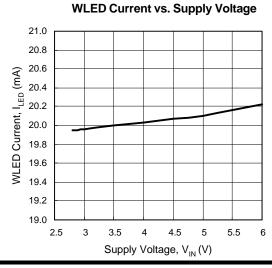


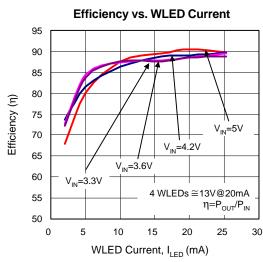
Typical Operating Characteristics

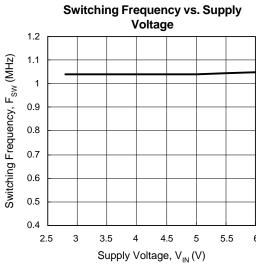
(Refer to figure 1 in the section "Typical Application Circuits", V_{IN} =3.6V, T_A =25°C, 6WLEDs unless otherwise specified)

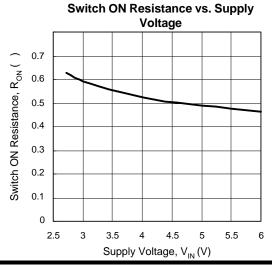








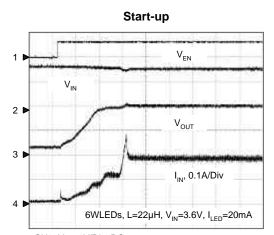




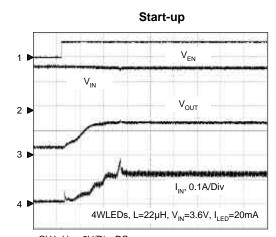


Operating Waveforms

(Refer to the application circuit in the section "Typical Application Circuits", V_{IN} =3.6V, T_A =25°C, 6WLEDs unless otherwise specified)

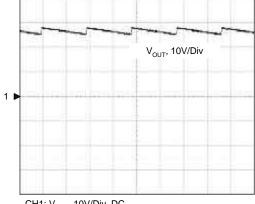


 $\begin{array}{l} \text{CH1: V}_{\text{EN}}, \, \text{2V/Div, DC} \\ \text{CH2: V}_{\text{IN}}, \, \text{2V/Div, DC} \\ \text{CH3: V}_{\text{OUT}}, \, \text{10V/Div, DC} \\ \text{CH4: I}_{\text{IN}}, \, \text{0.1A/Div, DC} \\ \text{Time: 1ms/Div} \end{array}$



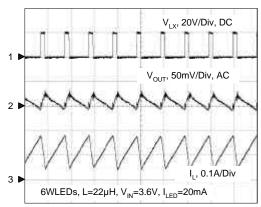
CH1: $V_{\rm EN}$, 2V/Div, DC CH2: $V_{\rm IN}$, 2V/Div, DC CH3: $V_{\rm OUT}$, 10V/Div, DC CH4: $I_{\rm IN}$, 0.1A/Div, DC Time: 1ms/Div

Open-LED Protection



CH1: V_{OUT} , 10V/Div, DC Time: 20ms/Div

Normal Operating Waveform



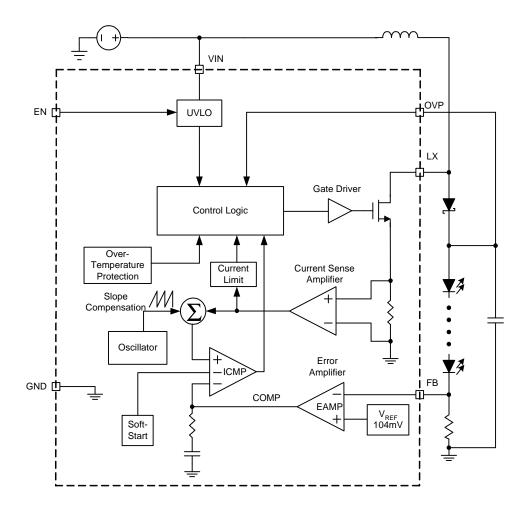
CH1: $\rm V_{LX}$, 20V/Div, DC CH2: $\rm V_{OUT}$, 50mV/Div, AC CH3: $\rm I_{L}$, 0.1A/Div, DC Time: 1 $\rm \mu s/Div$



Pin Description

Р	IN	FUNCTION
NO.	NAME	FUNCTION
1	LX	Switch pin. Connect this pin to inductor/diode here.
2	GND	Power and signal ground pin.
3	FB	Feedback Pin. Reference voltage is 104mV. Connect this pin to cathode of the lowest LED and resistor (R1). Calculate resistor value according to R1=104mV/I _{LED} .
4	EN	Enable Control Input. Forcing this pin above 1.0V enables the device, or forcing this pin below 0.4V to shut it down. In shutdown, all functions are disabled to decrease the supply current below $1\mu A$. Do not leave this pin floating.
5	OVP	Over-Voltage Protection pin. OVP is connected to the output capacitor of the converter.
6	VIN	Main Supply Pin. Must be closely decoupled to the GND with a 2.2μF or greater ceramic capacitor.

Block Diagram





Typical Application Circuits

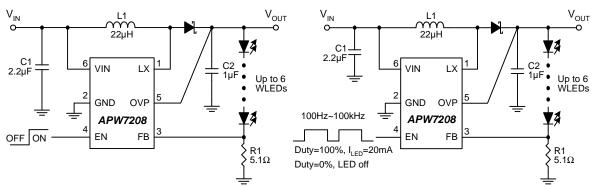


Figure 1. Typical 6 WLEDs Application

Figure 2. Brightness control using a PWM signal applies to EN

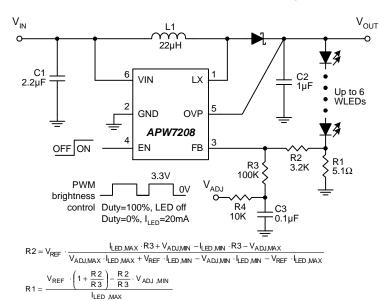


Figure 3. Brightness control using a filtered PWM signal

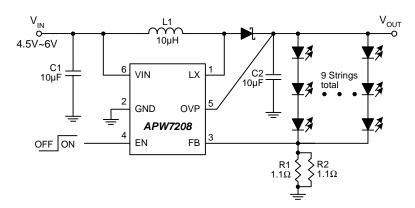


Figure 4. Circuit for driving 27 WLEDs



Function Description

Main Control Loop

The APW7208 is a constant frequency current-mode switching regulator. During normal operation, the internal N-channel power MOSFET is turned on each cycle when the oscillator sets an internal RS latch and turned off when an internal comparator (ICMP) resets the latch. The peak inductor current at which ICMP resets the RS latch is controlled by the voltage on the COMP node, which is the output of the error amplifier (EAMP). An external resistive divider connected between $\rm V_{OUT}$ and ground allows the EAMP to receive an output feedback voltage $\rm V_{FB}$ at FB pin. When the load current increases, it causes a slightly decrease in $\rm V_{FB}$ relative to the 104mV reference, which in turn causes the COMP voltage to increase until the average inductor current matches the new load current.

VIN Under-Voltage Lockout (UVLO)

The Under-Voltage Lockout (UVLO) circuit compares the input voltage at VIN with the UVLO threshold (2.3V rising, typical) to ensure the input voltage is high enough for reliable operation. The 100mV (typ) hysteresis prevents supply transients from causing a restart. Once the input voltage exceeds the UVLO rising threshold, start-up begins. When the input voltage falls below the UVLO falling threshold, the controller turns off the converter.

Soft-Start

The APW7208 has a built-in soft-start to control the N-channel MOSFET current rise during start-up. During soft-start, an internal ramp, connected to one of the inverting inputs, raise up to replace the output voltage of error amplifier until the ramp voltage reaches the V_{COMP} .

Current-Limit Protection

The APW7208 monitors the inductor current, flowing through the N-channel MOSFET, and limits the current peak at current-limit level to prevent loads and the APW7208 from damages during overload or short-circuit conditions.

Over-Temperature Protection (OTP)

The over-temperature circuit limits the junction temperature of the APW7208. When the junction temperature exceeds 150° C, a thermal sensor turns off the power MOSFET, allowing the devices to cool. The thermal sensor allows the converters to start a soft-start process and to regulate the output voltage again after the junction temperature cools by 40° C. The OTP is designed with a 40° C hysteresis to lower the average Junction Temperature (T_J) during continuous thermal overload conditions, increasing the lifetime of the device.

Enable/Shutdown

Driving EN to the ground places the APW7208 in shutdown mode. When in shutdown, the internal power MOSFET turns off, all internal circuitry shuts down and the quiescnet supply current reduces to $1\mu A$ maximum. This pin also could be used as a digital input allowing brightness control using a PWM signal from 100Hz to 100kHz. The 0% duty cycle of PWM signal corresponds to zero LEDs current and 100% corresponds to full one. Seggestion dimming duty range is from 7% to 100%.

Open-LED Protection

In driving LED applications, the feedback voltage on the FB pin falls down if one of the LEDs, in series, is failed. Meanwhile, the converter unceasingly boosts the output voltage like a open-loop operation. Therefore, an over-voltage protection (OVP), monitoring the output voltage via OVP pin, is integrated into the chip to prevent the LX and the output voltages from exceeding their maximum voltage ratings. When the voltage on the OVP pin rises above the OVP threshold (28V typical), the converter stops switching and prevents the output voltage from rising. The converter can work again when the falling OVP voltage falls below the OVP voltage threshold.



Application Information

Input Capacitor Selection

The input capacitor (C_{IN}) reduces the ripple of the input current drawn from the input supply and reduces noise injection into the IC. The reflected ripple voltage will be smaller when an input capacitor with larger capacitance is used. For reliable operation, it is recommended to select the capacitor with maximum voltage rating at least 1.2 times of the maximum input voltage. The capacitors should be placed close to the VIN and the GND.

Inductor Selection

Selecting an inductor with low dc resistance reduces conduction losses and achieves high efficiency. The efficiency is moderated while using small chip inductor which operates with higher inductor core losses. Therefore, it is necessary to take further consideration while choosing an adequate inductor. Mainly, the inductor value determines the inductor ripple current: larger inductor value results in smaller inductor ripple current and lower conduction losses of the converter. However, larger inductor value generates slower load transient response. A reasonable design rule is to set the ripple current, $\Delta I_{\rm L}$, to be 30% to 50% of the maximum average inductor current, $I_{\rm L(AVG)}$. The inductor value can be obtained as below,

$$L \ge \left(\frac{V_{IN}}{V_{OUT}}\right)^{\!\!2} \times \frac{V_{OUT} - V_{IN}}{F_{SW} \cdot I_{OUT(MAX)}} \times \frac{\eta}{\left(\frac{\Delta I_L}{I_{L(AVG)}}\right)}$$

where

 V_{IN} = input voltage

V_{OUT} = output voltage

 F_{sw} = switching frequency in MHz

 I_{OUT} = maximum output current in amp.

= Efficiency

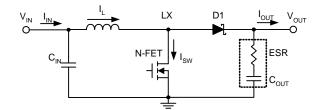
 $\Delta I_{L}/I_{L(AVG)}$ = inductor ripple current/average current (0.3 to 0.5 typical)

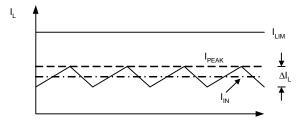
To avoid the saturation of the inductor, the inductor should be rated at least for the maximum input current of the converter plus the inductor ripple current. The maximum input current is calculated as below:

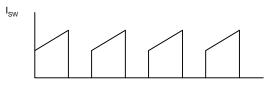
$$I_{IN(MAX)} = \frac{I_{OUT(MAX)} \cdot V_{OUT}}{V_{IN} \cdot \eta}$$

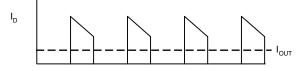
The peak inductor current is calculated as the following equation:

$$I_{PEAK} = I_{IN(MAX)} + \frac{1}{2} \cdot \frac{V_{IN} \cdot (V_{OUT} - V_{IN})}{V_{OUT} \cdot L \cdot F_{SW}}$$









Output Capacitor Selection

The current-mode control scheme of the APW7208 allows the usage of tiny ceramic capacitors. The higher capacitor value provides good load transients response. Ceramic capacitors with low ESR values have the lowest output voltage ripple and are recommended. If required, tantalum capacitors may be used as well. The output ripple is the sum of the voltages across the ESR and the ideal output capacitor.

$$\begin{split} &V_{\text{OUT}} = &V_{\text{ESR}} + &V_{\text{COUT}} \\ &\Delta V_{\text{COUT}} \approx \frac{I_{\text{OUT}}}{C_{\text{OUT}}} \cdot \left(\frac{V_{\text{OUT}} - V_{\text{IN}}}{V_{\text{OUT}} \cdot F_{\text{SW}}} \right) \end{split}$$

$$\Delta V_{ESR} \approx I_{PEAK} \cdot R_{ESR}$$

where I_{PEAK} is the peak inductor current.



Application Information (Cont.)

Output Capacitor Selection (Cont.)

For ceramic capacitor application, the output voltage ripple is dominated by the ΔV_{COUT} . When choosing the input and output ceramic capacitors, the X5R or X7R with their good temperature and voltage characteristics are recommended.

Diode Selection

To achieve high efficiency, a Schottky diode must be used. The current rating of the diode must meet the peak current rating of the converter.

Setting the LED Current

In figure 1, the converter regulates the voltage on the FB pin, connected with the cathod of the lowest LED and the current-sense resistor R1, at 104mV (typical). Therefore, the current (I_{LED}), flowing via the LEDs and the R1, is calculated by the following equation:

 $I_{LED} = 104 \text{mV/R1}$

Recommended Inductor Selection

Designator	Manufacturer	Part Number	Inductance (µH)	Max DCR (ohm)	Saturation Current (A)	Dimensions L x W x H (mm ³)
L1	GOTREND	GTSD-32-220	22	0.592	0.52	3.85 x 3.85 x 1.8

Recommended Capacitor Selection

Designator	Manufacturer	Part Number	Capacitance (µF)	TC Code	Rated Voltage (V)	Case size
C1	Murata	GRM188C70J225KE20	2.2	X7S	6.3	0603
C2	Murata	GRM21BR71H105KA12	1.0	X7R	50	0805

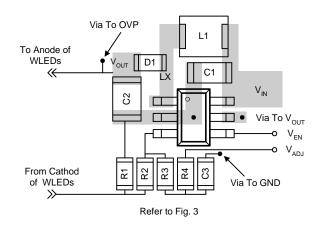
Recommended Diode Selection

Designator	Manufacturer	Part Number	Maximum average forward rectified current (A)	Maximum repetitive peak reverse voltage (V)	Case size
D1	Zowie	MSCD104	1.0	40	0805

Layout Consideration

For all switching power supplies, the layout is an important step in the design; especially at high peak currents and switching frequencies. If the layout is not carefully done, the regulator might show noise problems and duty cycle jitter.

- The input capacitor should be placed close to the VIN and the GND. Connecting the capacitor with VIN and GND pins by short and wide tracks without using any vias for filtering and minimizing the input voltage ripple.
- The inductor should be placed as close as possible to the LX pin to minimize length of the copper tracks as well as the noise coupling into other circuits.
- 3. Since the feedback pin and network is a high impedance circuit, the feedback network should be routed away from the inductor. The feedback pin and feedback network should be shielded with a ground plane or track to minimize noise coupling into this circuit.
- A star ground connection or ground plane minimizes ground shifts and noise is recommended.

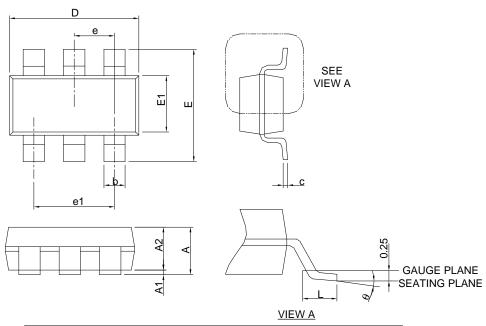


Optimized APW7208 Layout



Package Information

SOT-23-6



Ş	SOT-23-6						
S≻MBOL	MILLIM	ETERS	INC	HES			
P P	MIN.	MAX.	MIN.	MAX.			
Α		1.45		0.057			
A1	0.00	0.15	0.000	0.006			
A2	0.90	1.30	0.035	0.051			
b	0.30	0.50	0.012	0.020			
С	0.08	0.22	0.003	0.009			
D	2.70	3.10	0.106	0.122			
Е	2.60	3.00	0.102	0.118			
E1	1.40	1.80	0.055	0.071			
е	0.95 BSC		0.03	7 BSC			
e1	1.90 BSC		0.07	5 BSC			
L	0.30	0.60	0.012	0.024			
θ	0°	8°	0°	8°			

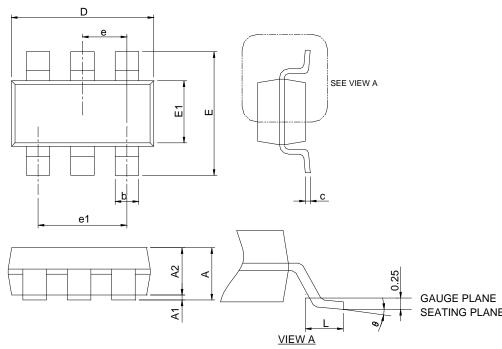
Note: 1. Follow JEDEC TO-178 AB.

Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.



Package Information

TSOT-23-6



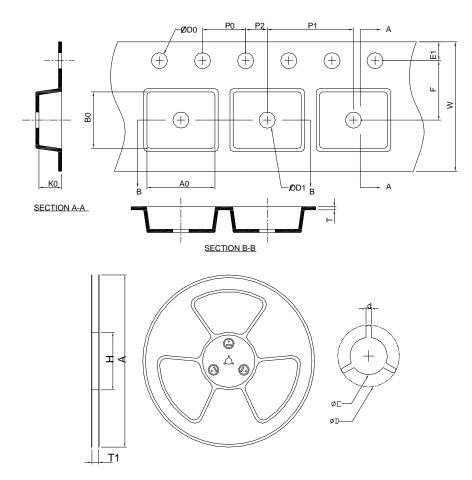
Ş	TSOT-23-6						
SYM BOL	MILLIM	MILLIMETERS		HES			
2	MIN.	MAX.	MIN.	MAX.			
Α	0.75	0.80	0.030	0.031			
A1	0.03	0.05	0.001	0.002			
A2	0.70	0.75	0.028	0.030			
b	0.30	0.50	0.012	0.020			
С	0.08	0.20	0.003	0.008			
D	2.70	3.10	0.106	0.122			
Е	2.60	3.00	0.102	0.118			
E1	1.40	1.80	0.055	0.071			
е	0.95	BSC	0.03	7 BSC			
e1	1.90 BSC		0.07	5 BSC			
L	0.30	0.60	0.012	0.024			
θ	0°C	8°C	0°C	8°C			

Note: 1. Followed from JEDEC TO-178 AB.

2. Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.



Carrier Tape & Reel Dimensions



Application	Α	Н	T1	С	d	D	W	E1	F
	178.0	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0 ±0.30	1.75 ±0.10	3.5 ±0.05
SOT-23-6	P0	P1	P2	D0	D1	Т	A0	В0	K0
	4.0 ±0.10	4.0 £ 0.10	2.0 ±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20 ± 0.20	3.10 ±0.20	1.50 ±0.20
Application	Α	Н	T1	С	d	D	W	E1	F
	178.0 ₤.00	50 MIN.	8.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	8.0 ±0.30	1.75 ±0.10	3.5 ±0.05
TSOT-23-6	P0	P1	P2	D0	D1	T	A0	В0	K0
	4.0 ± 0.10	4.0 ± 0.10	2.0 ±0.05	1.5+0.10 -0.00	1.0 MIN.	0.6+0.00 -0.40	3.20 ±0.20	3.10 ±0.20	1.50 ±0.20

(mm)

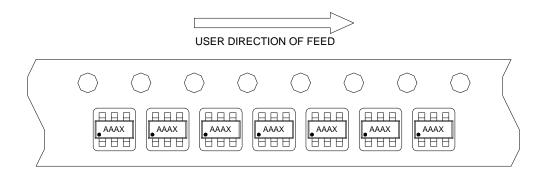
Devices Per Unit

Package Type	Unit	Quantity
SOT-23-6	Tape & Reel	3000
TSOT-23-6	Tape & Reel	3000

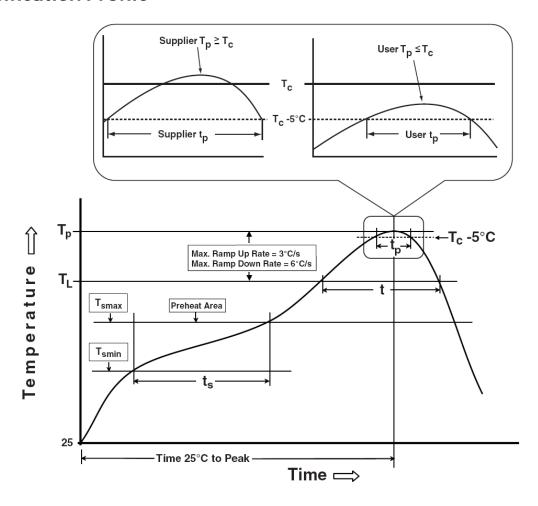


Taping Direction Information

SOT-23-6/TSOT-23-6



Classification Profile





Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly		
Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds		
Average ramp-up rate (T _{smax} to T _P)	3 °C/second max.	3°C/second max.		
Liquidous temperature (T _L) Time at liquidous (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds		
Peak package body Temperature (T _p)*	See Classification Temp in table 1	See Classification Temp in table 2		
Time $(t_P)^{**}$ within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds		
Average ramp-down rate (T _p to T _{smax})	6 °C/second max.	6 °C/second max.		
Time 25°C to peak temperature	6 minutes max.	8 minutes max.		
* Tolerance for peak profile Temperature (T _D) is defined as a supplier minimum and a user maximum.				

^{*} Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum.

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package	Volume mm ³	Volume mm ³	
Thickness	<350	³350	
<2.5 mm	235 °C	220 °C	
≥2.5 mm	220 °C	220 °C	

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description	
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C	
HOLT	JESD-22, A108	1000 Hrs, Bias @ T _j =125°C	
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C	
тст	JESD-22, A104	500 Cycles, -65°C~150°C	
НВМ	MIL-STD-883-3015.7	VHBM 2KV	
MM	JESD-22, A115	VMM 200V	
Latch-Up	JESD 78	10ms, 1 _{tr} 100mA	

^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.



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